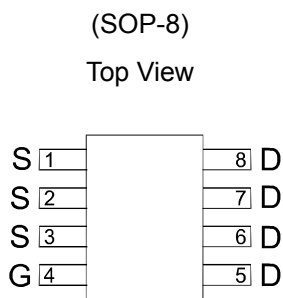


N-Channel 30-V (D-S) MOSFET

GENERAL DESCRIPTION

The ME4412 is the N-Channel logic enhancement mode power field effect transistors are produced using high cell density, DMOS trench technology. This high density process is especially tailored to minimize on-state resistance. These devices are particularly suited for low voltage application such as cellular phone and notebook computer power management and other battery powered circuits where high-side switching, and low in-line power loss are needed in a very small outline surface mount package.

PIN CONFIGURATION



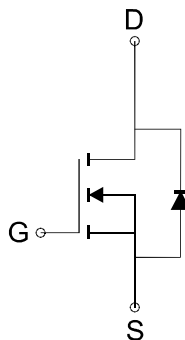
Ordering Information: ME4412 (Pb-free)
ME4412-G (Green product-Halogen free)

FEATURES

- R_{DS(ON)} 18 mΩ@V_{GS}=10V
- R_{DS(ON)} 30 mΩ@V_{GS}=4.5V
- Super high density cell design for extremely low R_{DS(ON)}
- Exceptional on-resistance and maximum DC current capability

APPLICATIONS

- Power Management in Note book
- Portable Equipment
- Battery Powered System
- DC/DC Converter
- Load SwitchC
- LCD Display inverter



N-Channel MOSFET

Absolute Maximum Ratings (T_A=25 Unless Otherwise Noted)

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	V _{DSS}	30	V
Gate-Source Voltage	V _{GSS}	±20	V
Continuous Drain Current	I _D	T _A =25	9.3
		T _A =70	7.5
Pulsed Drain Current	I _{DM}	37	A
Maximum Power Dissipation	P _D	T _A =25	2.5
		T _A =70	1.6
Operating Junction Temperature	T _J	-55 to 150	
Thermal Resistance-Junction to Ambient*	R _{θJA}	50	/W

*The device mounted on 1in² FR4 board with 2 oz copper



N-Channel 30-V (D-S) MOSFET

Electrical Characteristics (T_A = 25 °C Unless Otherwise Specified)

Symbol	Parameter	Limit	Min	Typ	Max	Unit
STATIC						
V _{(BR)DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =250 μA	30			V
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =250 μA	1.0		3.0	V
I _{GSS}	Gate Leakage Current	V _{DS} =0V, V _{GS} =±20V			±100	nA
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =30V, V _{GS} =0V			1	μA
R _{DS(ON)}	Drain-Source On-State Resistance ^a	V _{GS} =10V, I _D = 10A		14	18	m
		V _{GS} =4.5V, I _D = 5A		23	30	
V _{SD}	Diode Forward Voltage	I _S =2.3A, V _{GS} =0V		0.76	1.1	V
DYNAMIC						
Q _g	Gate Charge	V _{DS} =15V, V _{GS} =10V, I _D =10A		16		nC
Q _{gt}	Total Gate Charge	V _{DS} =15V, V _{GS} =4.5V, I _D =10A		8		
Q _{gs}	Gate-Source Charge			3.8		
Q _{gd}	Gate-Drain Charge			3.3		
C _{iss}	Input capacitance	V _{DS} =-15V, V _{GS} =0V, f=1MHz		536		pF
C _{oss}	Output Capacitance			97		
C _{rss}	Reverse Transfer Capacitance			31		
R _g	Gate Resistance	f = 1MHz		0.9		
t _{d(on)}	Turn-On Delay Time	V _{DD} =25V, R _L =25 I _D =1A, V _{GEN} =10V R _G =6		12		ns
t _r	Turn-On Rise Time			10		
t _{d(off)}	Turn-Off Delay Time			40		
t _f	Turn-On Fall Time			6		

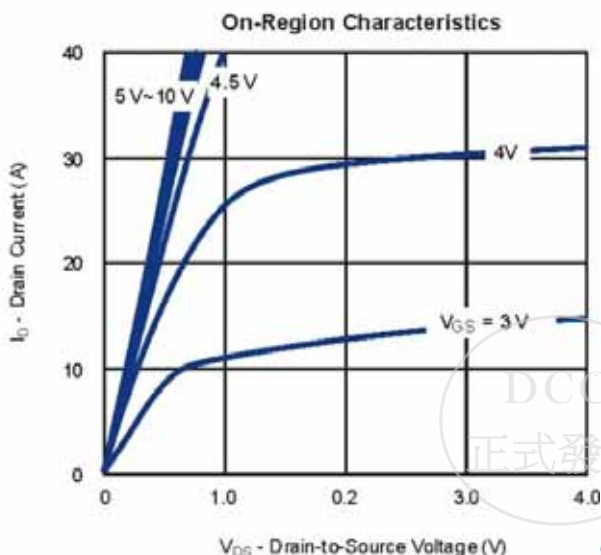
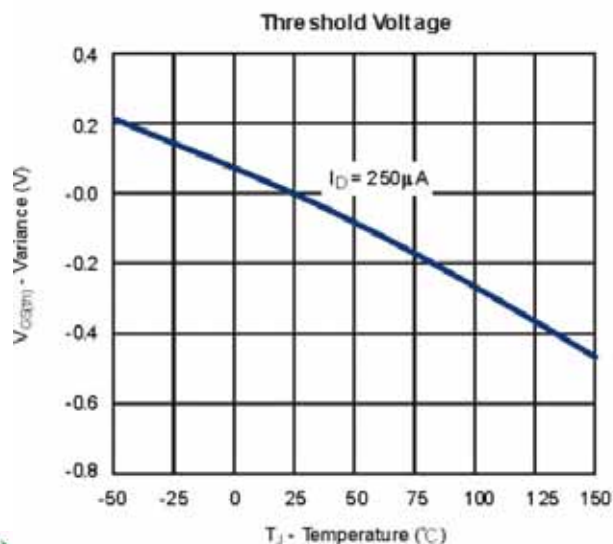
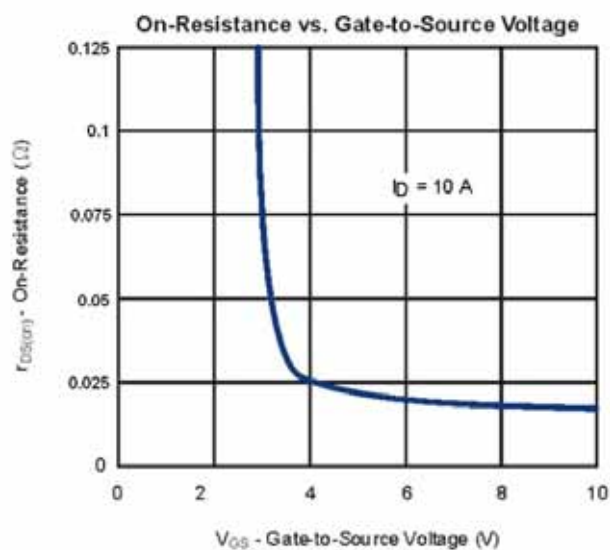
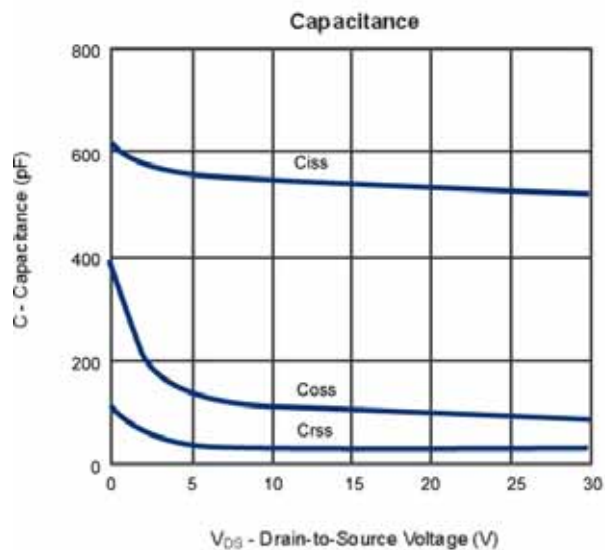
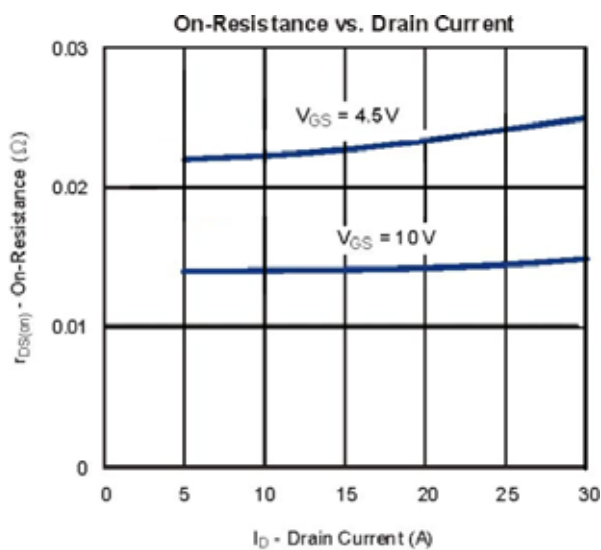
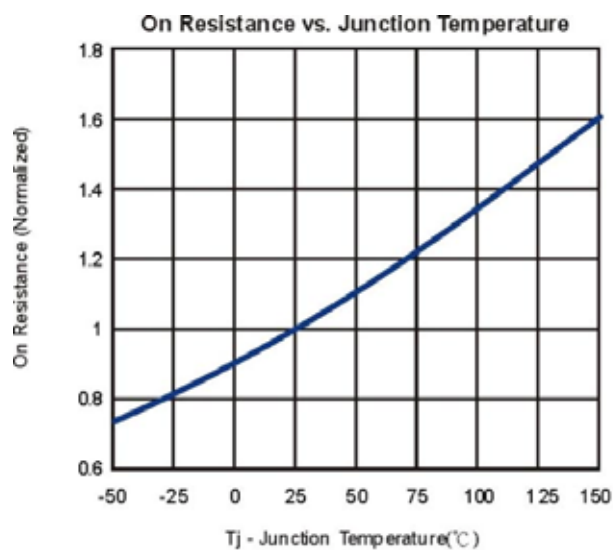
Notes: a. Pulse test: pulse width 300us, duty cycle 2%, Guaranteed by design, not subject to production testing.

b. Matsuki reserves the right to improve product design, functions and reliability without notice.

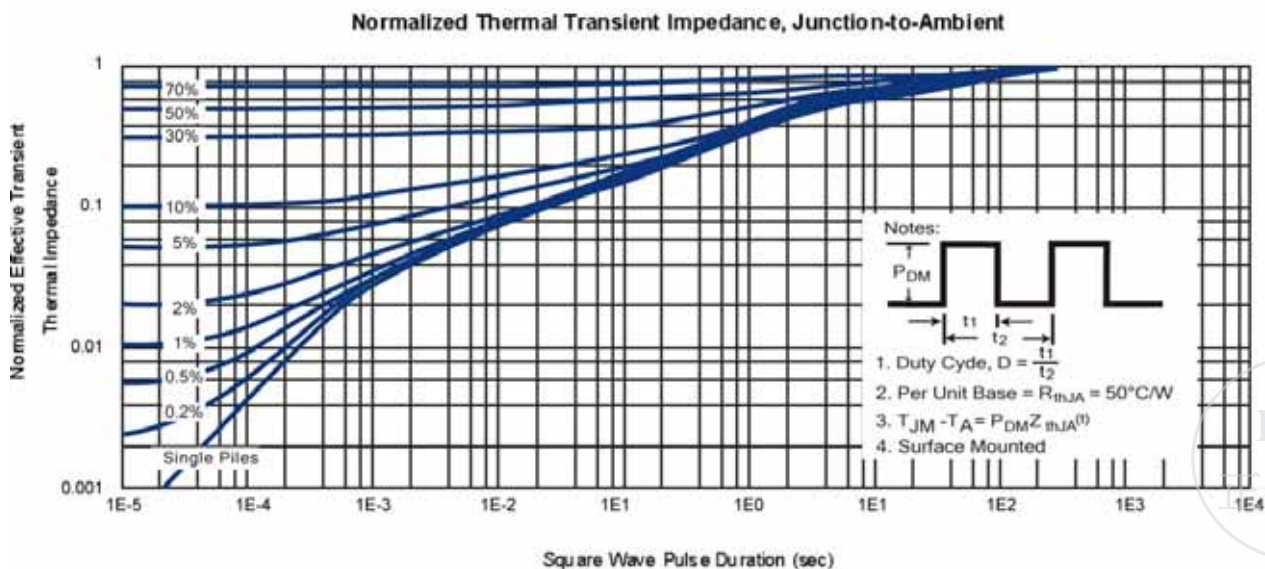
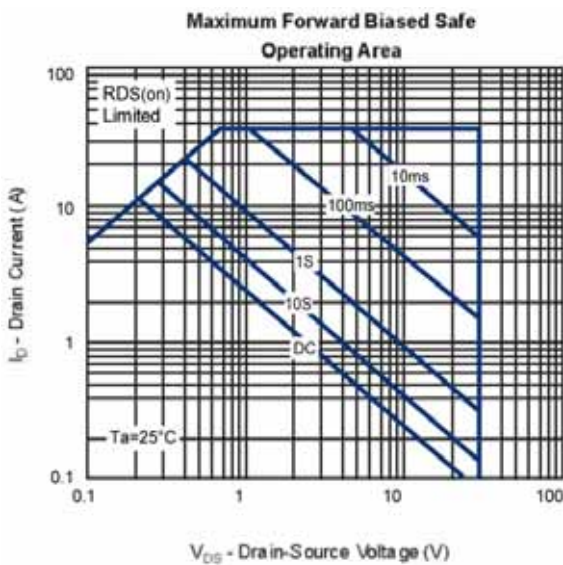
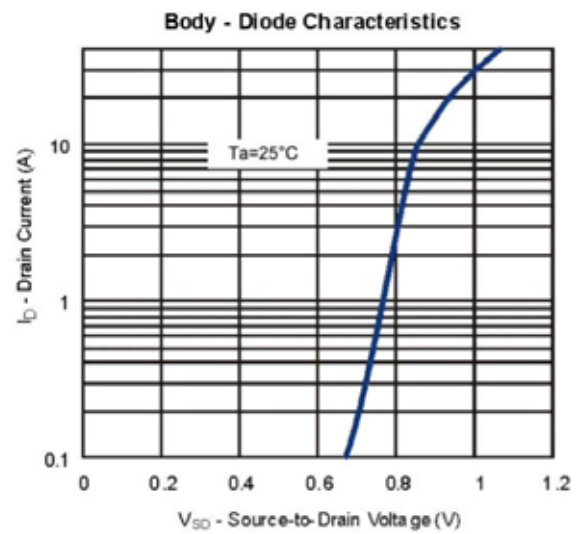
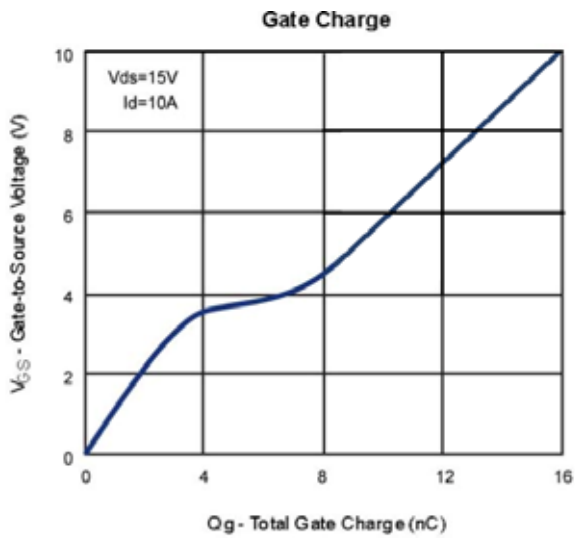


N-Channel 30-V (D-S) MOSFET

Typical Characteristics (T_J = 25 Noted)

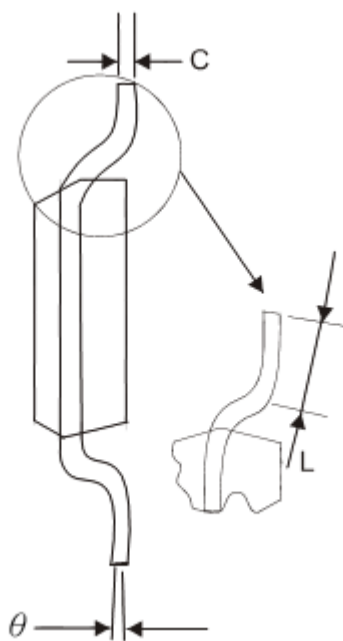
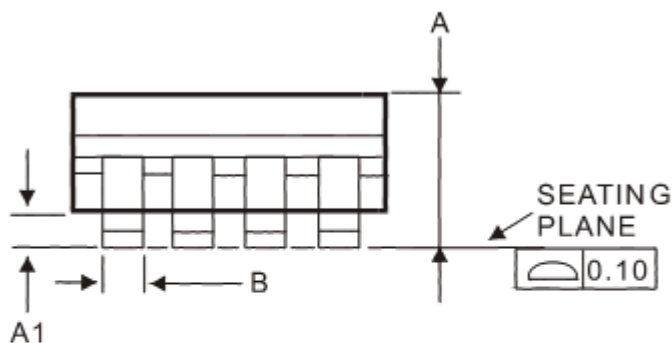
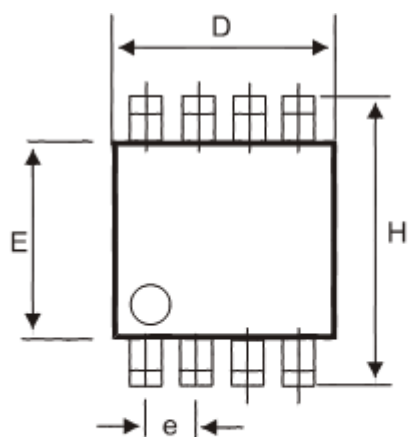


Typical Characteristics (T_J =25°C Noted)



DCC
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SOP-8 Package Outline



Symbol	MILLIMETERS (mm)	
	MIN	MAX
A	1.35	1.75
A1	0.10	0.25
B	0.35	0.49
C	0.18	0.25
D	4.80	5.00
E	3.80	4.00
e	1.27 BSC	
H	5.80	6.20
L	0.40	1.25
θ	0°	7°

